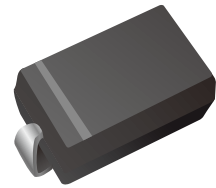


General Purpose Silicon Rectifier

Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Construction utilizes void-free molded plastic technique
- Low reverse leakage
- High forward surge current capability
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case:SMA
- Terminals: leads solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any

Ordering Information

Part Number	Marking	Shipping	Reel
LTM520A-TR5	M520	5000PCS Tape&Reel	13 inchs
LTM520A-TR7K5	M520	7500PCS Tape&Reel	13 inchs

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.
 Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Rating	Symbol	LTM520A	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	2000	V
Maximum RMS voltage	V_{RMS}	1400	V
Maximum DC blocking voltage	V_{DC}	2000	V
Maximum average forward rectified current 0.375"(9.5mm) lead length at $T_A=75^\circ\text{C}$	$I_{(AV)}$	1	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30	A
Maximum instantaneous forward voltage at 1.0 A	V_F	2	V
Maximum DC reverse current at rated DC blocking voltage $T_A=25^\circ\text{C}$ $T_A=100^\circ\text{C}$	I_R	5 50	μA
Typical junction capacitance (Note 1)	C_J	15	pF
Typical thermal resistance (Note 2)	$R_{\theta JA}$	95	$^\circ\text{C/W}$
Operating junction and storage temperature range	T_J, T_{STG}	-50 to +150	$^\circ\text{C}$

Note:(1) Measured at 1MHz and applied reverse voltage of 4.0V D.C.

(2) Thermal resistance from junction to ambient at 0.2 "(5mm) lead length, P.C.B. mounted



Characteristics Curves

FIG. 1 FORWARD CURRENT DERATING CURVE

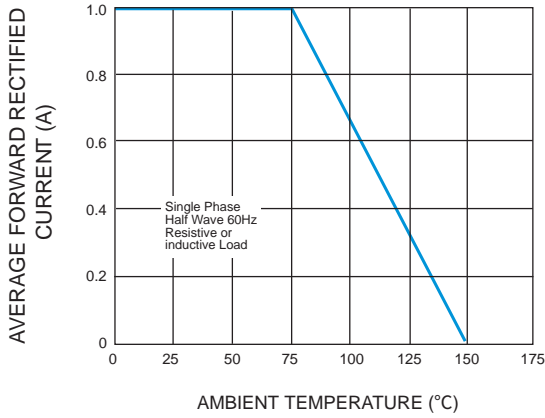


FIG. 2 MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

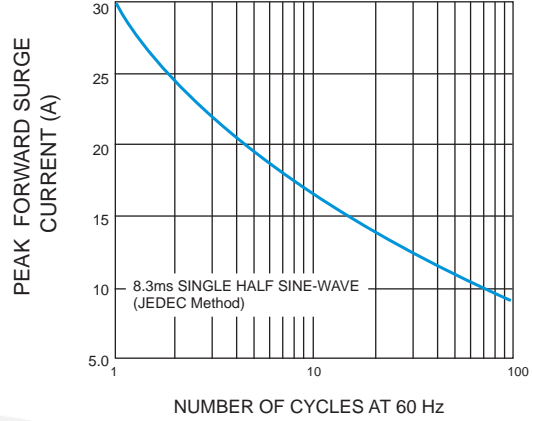


FIG. 3 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

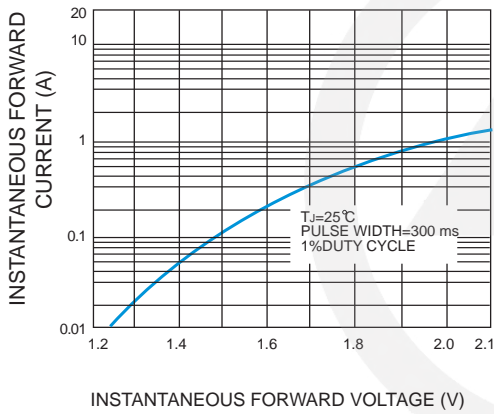


FIG. 4 TYPICAL REVERSE CHARACTERISTICS

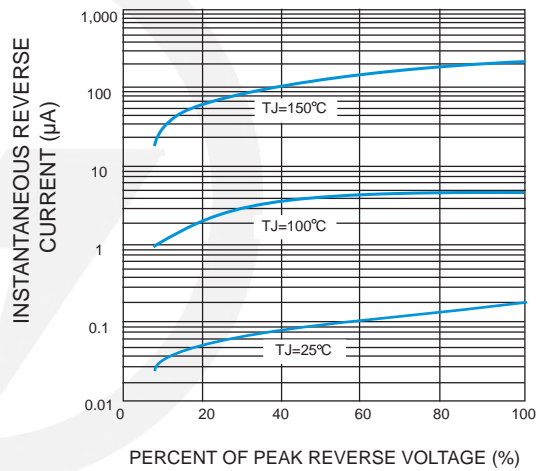


FIG. 5 TYPICAL JUNCTION CAPACITANCE

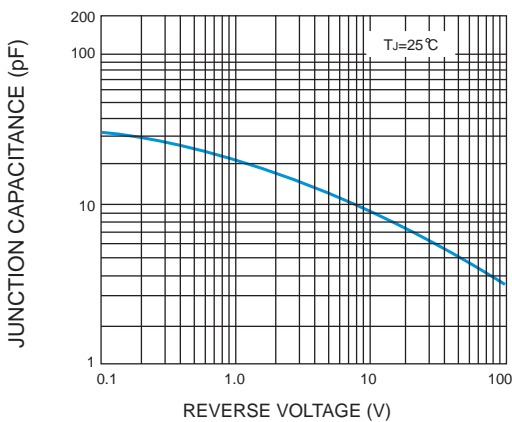
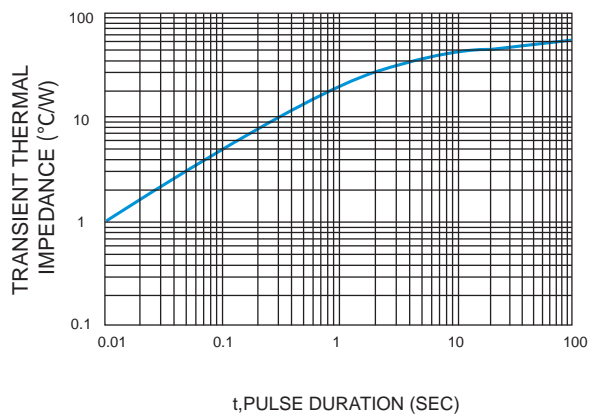
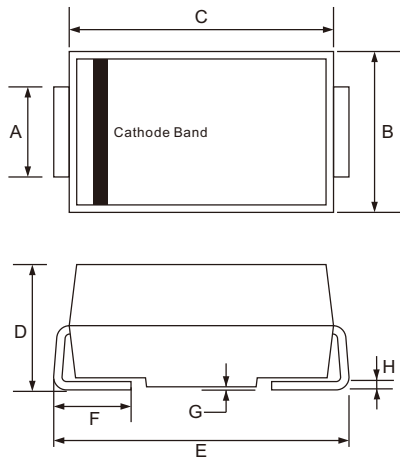


FIG. 6 TYPICAL TRANSIENT THERMAL IMPEDANCE



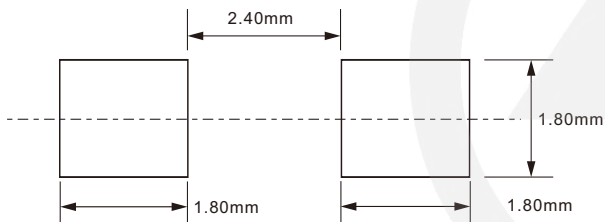
SMA Package Outline



Unit: mm

SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.25	1.65
B	2.30	2.79
C	3.90	4.75
D	1.90	2.50
E	4.70	5.28
F	0.76	1.52
G	0.203 TYP.	
H	0.15	0.31

SMA Suggested Pad Layout

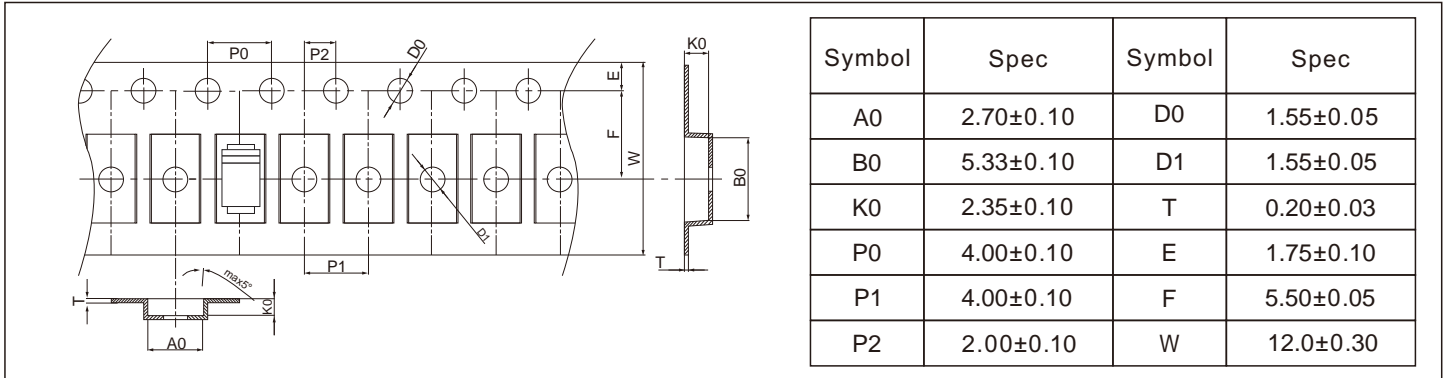


Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purpose only.

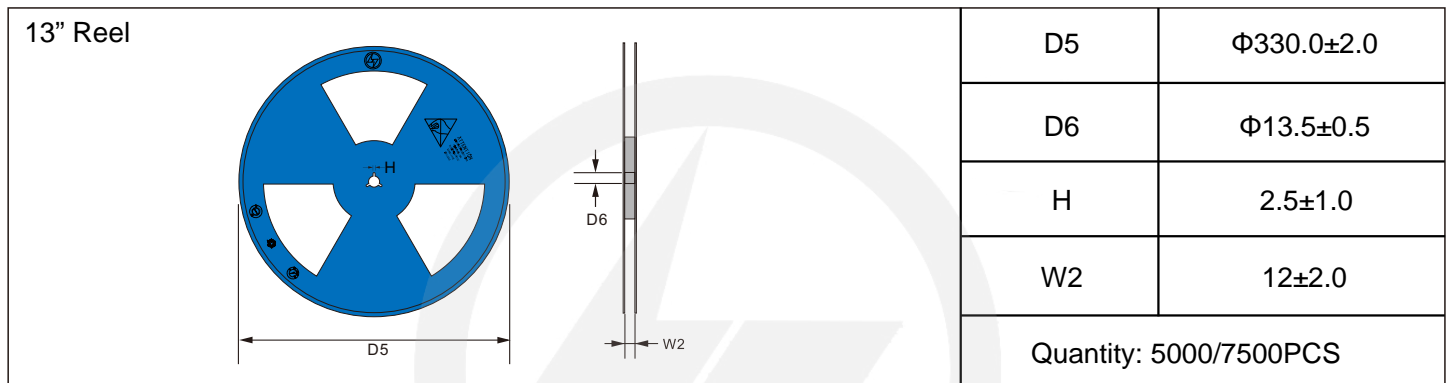
Carrier Tape Dimensions

Unit : mm

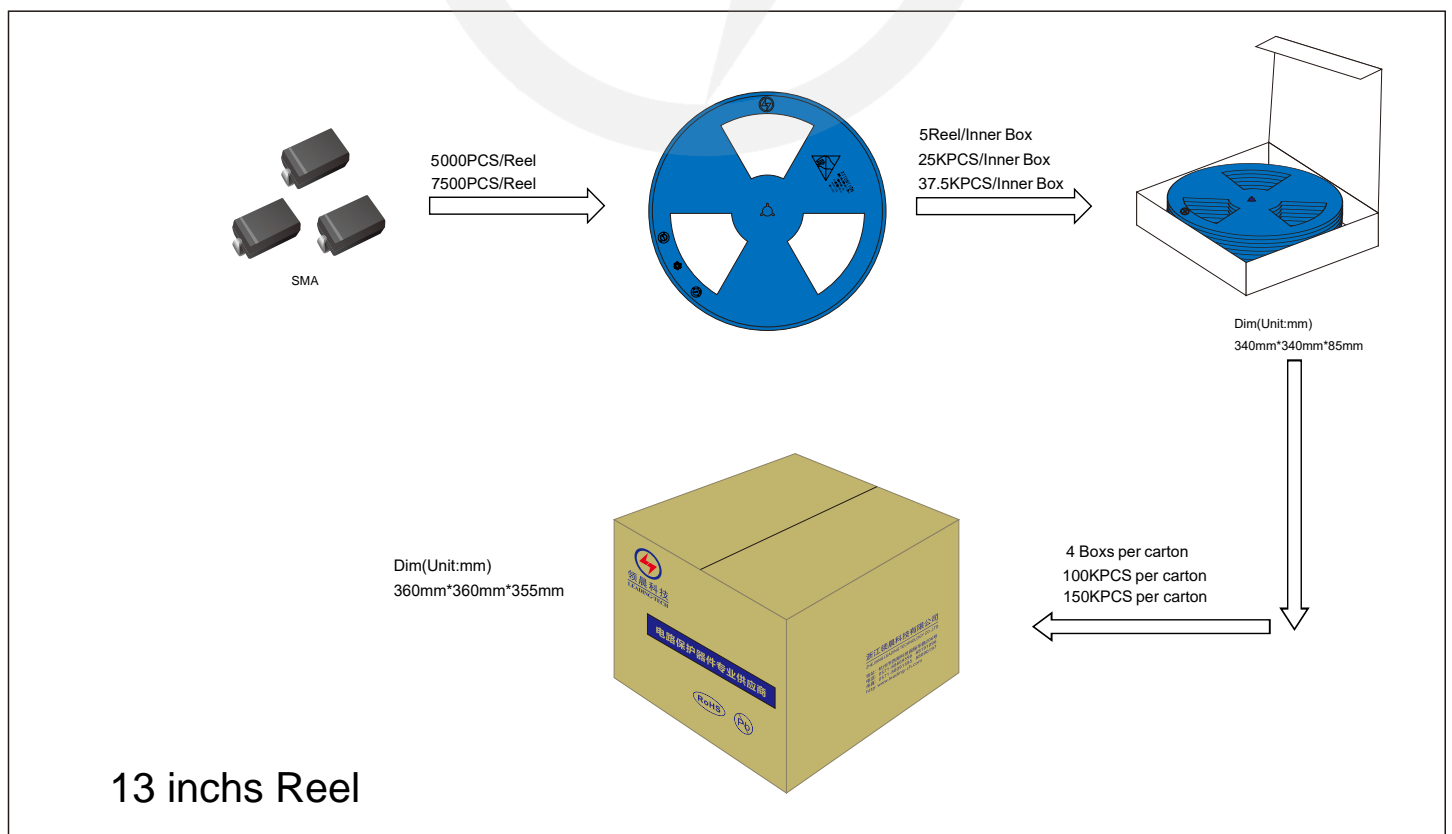


Reel Dimensions

Unit : mm



Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	3°C/second max.
Preheat	
-Temperature Min (T _{S min})	150°C
-Temperature Max (T _{S max})	200°C
-Time (min to max) (t _s)	60-180 seconds
T _{S max} to T _L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T _L)	217°C
-Time (t _L)	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Important Notice and Disclaimer

Leading-Tech reserves the right to make changes to this document and its products and specifications at any time without notice.

Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

Leading-Tech makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, not does Leading-Tech assume any liability for application assistance or customer product design.

Leading-tech does not warrant or accept any liability with products which are purchase or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Leading-Tech.

Leading-Tech products are not authorized for use as critical components in life support devices or systems without express written approval of Leading-tech.

Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.03.16	2024.03.16	3.0	New File	/	Ding	
02	2025.06.17	2025.06.17	3.1	Update packaging information	/	Ding	